

ON Semiconductor®

FDS6675BZ P-Channel PowerTrench[®] MOSFET -30V, -11A, 13mΩ

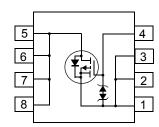
General Description

This P-Channel MOSFET is producted using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance.

This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.







Features

r_{DS(on)}

RoHS Compliant

• Max $r_{DS(on)}$ = 13m Ω at V_{GS} = -10V, I_D = -11A

• Max $r_{DS(on)} = 21.8 m\Omega$ at $V_{GS} = -4.5 V$, $I_D = -9 A$

High power and current handing capability

■ Extended V_{GS} range (-25V) for battery applications

■ HBM ESD protection level of 5.4 KV typical (note 3)

■ High performance trench technology for extremely low

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		-30	V
V _{GS}	Gate to Source Voltage		±25	V
I _D	Drain Current -Continuous	(Note 1a)	-11	^
	-Pulsed		-55	Α
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	
		(Note 1b)	1.2	W
		(Note 1c)	1.0	
T _J , T _{STG}	Operating and Storage Temperature		-55 to 150	°C

Thermal Characteristics

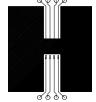
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	50	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case (Note 1)	25	°C/W

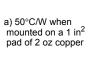
Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS6675BZ	FDS6675BZ	13"	12mm	2500 units

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teristics		Min	Тур	Max	Units
Drain to Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-30			V
Breakdown Voltage Temperature Coefficient	I_D = -250µA, referenced to 25°C		-20		mV/°C
Zero Gate Voltage Drain Current	V _{DS} = -24V, V _{GS} = 0V			-1	μA
Gate to Source Leakage Current	V_{GS} = ±25V, V_{DS} = 0V			±10	μA
teristics (Note 2)					
	V _{CS} = V _{DS} . I _D = -250µA	-1	-2	-3	V
Gate to Source Threshold Voltage	$I_D = -250 \mu A$, referenced to $25^{\circ}C$		15.7	-	mV/°C
	V _{GS} = -10V , I _D = -11A		10.8	13.0	
Desis to Course On Desistance			17.4	21.8	mΩ
Drain to Source On Resistance	V _{GS} = -10V, I _D = -11A		15.0	18.8	
Forward Transconductance	V _{DS} = -5V, I _D = -11A		34		S
haracteristics	$V_{DS} = -15V_{CS} = 0V_{CS}$		1855	2470	pF
Output Capacitance			335	450	pF
Reverse Transfer Capacitance			330	500	pF
Characteristics (Note 2)					
Turn-On Delay Time			3.0	10	ns
Rise Time			7.8	16	ns
Turn-Off Delay Time	$V_{GS} = -10V, R_{GS} = 6\Omega$		120	200	ns
Fall Time			60	100	ns
Total Gate Charge	V _{DS} = -15V, V _{GS} = -10V, I _D = -11A		44	62	nC
Total Gate Charge			25	35	nC
Gate to Source Gate Charge			7.2		nC
Gate to Drain Charge			11.4		nC
	Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Drain to Source On Resistance Forward Transconductance haracteristics nput Capacitance Dutput Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Furn-On Delay Time Rise Time Furn-Off Delay Time Fall Time Fotal Gate Charge Gate to Source Gate Charge	Coefficient 25° CZero Gate Voltage Drain Current $V_{DS} = -24V, V_{GS} = 0V$ Gate to Source Leakage Current $V_{GS} = \pm 25V, V_{DS} = 0V$ Gate to Source Threshold Voltage $V_{GS} = \pm 25V, V_{DS} = 0V$ Gate to Source Threshold Voltage $I_D = -250\mu$ A, referenced to 25° CDrain to Source On Resistance $V_{GS} = -10V, I_D = -11A$ Orain to Source On Resistance $V_{GS} = -4.5V, I_D = -9A$ VGS = -10V, I_D = -11A $V_{GS} = -10V, I_D = -11A$ T_J = 125^{\circ}C $V_{DS} = -5V, I_D = -9A$ Porain to Source On Resistance $V_{DS} = -5V, I_D = -11A$ Turacteristics $V_{DS} = -5V, I_D = -11A$ Nput Capacitance $V_{DS} = -15V, V_{GS} = 0V,$ Characteristics (Note 2) $V_{DD} = -15V, I_D = -11A$ Turn-On Delay Time $V_{DS} = -15V, V_{GS} = 6\Omega$ Fail Time $V_{DS} = -15V, V_{GS} = -10V,$ Total Gate Charge $V_{DS} = -15V, V_{GS} = -5V,$ Gate to Source Gate Charge $V_{DS} = -15V, V_{GS} = -5V,$ Gate to Source Gate Charge $V_{DS} = -15V, V_{GS} = -5V,$	Coefficient 25° CZero Gate Voltage Drain Current $V_{DS} = -24V, V_{GS} = 0V$ Gate to Source Leakage Current $V_{GS} = \pm 25V, V_{DS} = 0V$ Gate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = -250\mu$ A-1Gate to Source Threshold Voltage $I_D = -250\mu$ A, referenced to 25° C-1Gate to Source On Resistance $V_{GS} = -10V, I_D = -11A$ -1Drain to Source On Resistance $V_{GS} = -4.5V, I_D = -9A$ -1Forward Transconductance $V_{DS} = -5V, I_D = -11A$ -1haracteristics $V_{DS} = -5V, I_D = -11A$ -1nput Capacitance $V_{DS} = -5V, I_D = -11A$ -1Dutput Capacitance $V_{DS} = -15V, V_{GS} = 0V, f = 1MHz$ -1Characteristics (Note 2) $V_{DD} = -15V, I_D = -11A$ -1Furn-On Delay Time $V_{DS} = -15V, V_{GS} = 6\Omega$ -1Fall Time $V_{DS} = -15V, V_{GS} = -10V, I_D = -11A$ -1Fotal Gate Charge $V_{DS} = -15V, V_{GS} = -10V, I_D = -11A$ -1Total Gate Charge $V_{DS} = -15V, V_{GS} = -10V, I_D = -11A$ -1Total Gate Charge $V_{DS} = -15V, V_{GS} = -5V, I_D = -11A$ -1Total Gate Charge $V_{DS} = -15V, V_{GS} = -5V, I_D = -11A$ -1Total Gate Charge $V_{DS} = -15V, V_{GS} = -5V, I_D = -11A$ -1Total Gate Charge $V_{DS} = -15V, V_{GS} = -5V, I_D = -11A$ -1	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $







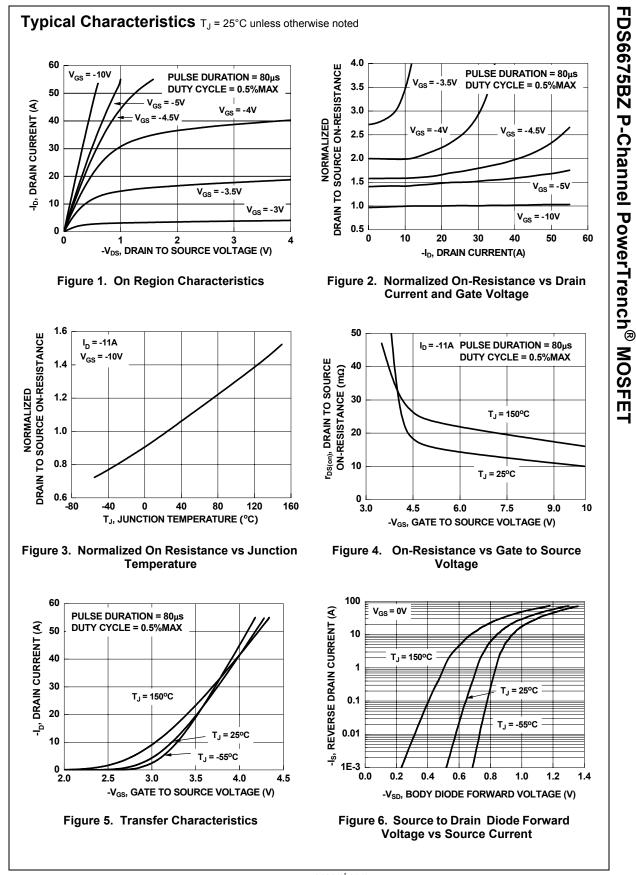
b)105°C/W when
mounted on a .04 in ²
pad of 2 oz copper

c) 125°C/W when mounted on a minimun pad

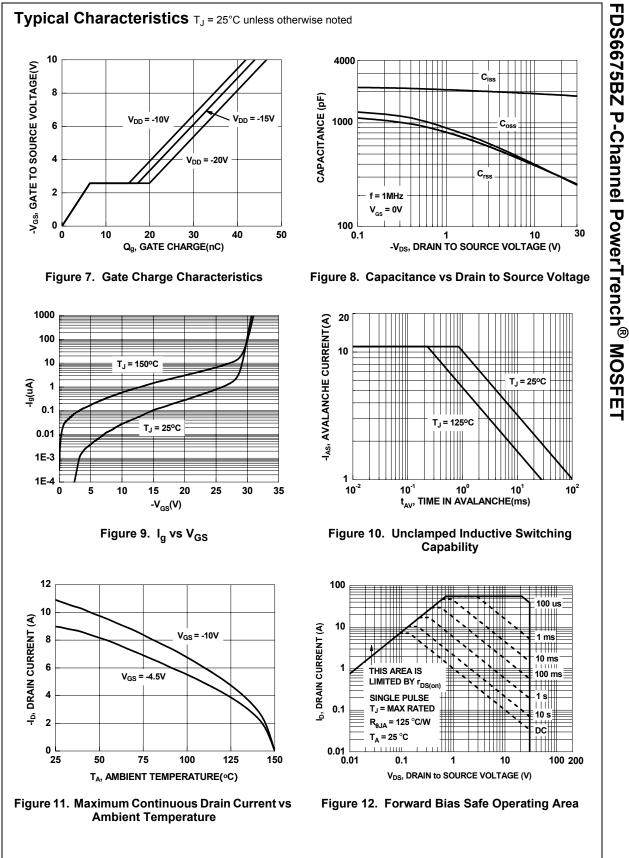
Scale 1 : 1 on letter size paper

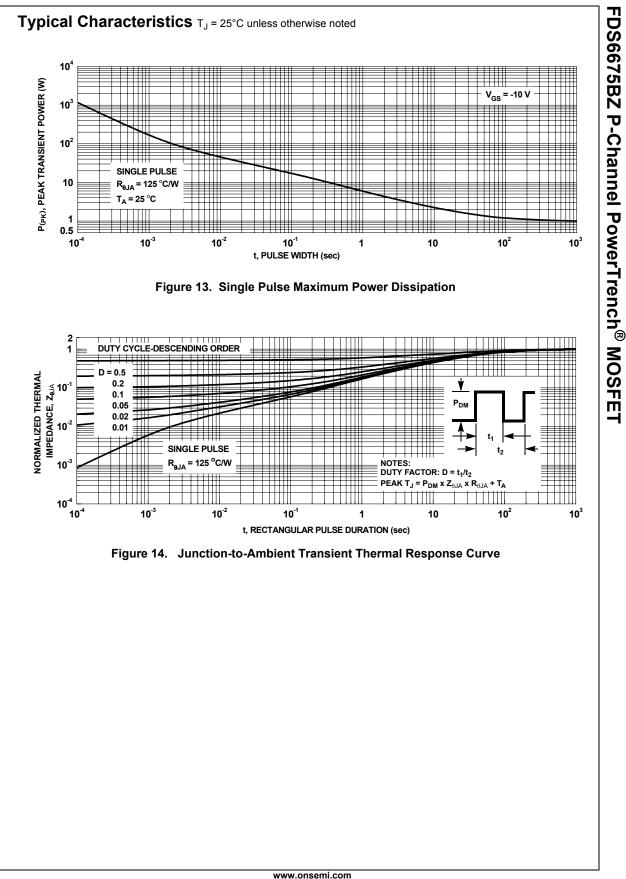
Pulse Test:Pulse Width <300 us, Duty Cycle < 2.0%
 The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

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